S E R V I C E N O T E

SUPERSEDES: None

3070 Board Test System

New firmware improves performance

Problem:

MTD has found an existing flaw in the firmware on the LCU card in the POTS bay. This flaw causes random relay failures in DGN tests. In rare cases, it also can randomly close relays during customer use.

Solution:

The flawed PROM was replaced in all systems that started shipping after 2/6/96. All PROMs in existing Series I and Series II POTS systems need to be replaced. A list of customers with E1085A orders has been created. The CEs for these orders will be contacted to determine the best process for each customer.

The affected PROM is a 20 pin J-lead PLCC device that requries a surface mount solder reflow tool to replace. Some customers may have this tool. If the customer and CE are able to remove the solder surface mount ICs, the PROM replacement can be done at the customer's site. A loan of LCU boards may be needed to shorten the down time.

If the customer is not able to do the PROM replacement, the boards will need to be returened to the factory. The loaner boards can be used during this time.

Billing Information:

MTD will pay for 2 hours (parts and labor) to cover the cost of the upgrade. Reference this Service Note number on the billing.

DATE: June 1996

ADMINISTRATIVE INFORMATION

SERVICE NOTE CLASSIFICATION:		
MODIFICATION RECOMMENDED		
ACTION CATEGORY:	☐ IMMEDIATELY ☐ ON SPECIFIED FAILURE ☐ AGREEABLE TIME	STANDARDS: Labor 2.0 hrs
LOCATION CATEGORY:	☐ CUSTOMER INSTALLABLE ☐ ON-SITE ☐ SERVICE CENTER	SERVICE RETURN USED RETURN INVENTORY: SCRAP PARTS: SCRAP SEE TEXT SEE TEXT
AVAILABILITY:	PRODUCT'S SUPPORT LIFE	AGILENT RESPONSIBLE UNTIL: June 1998
AUTHOR: GS	ENTITY: 0980	ADDITIONAL INFORMATION:

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